



Quality HeLiTai

QUALITY MICROELECTRONICS(SHENZHEN)CO.,LTD

high quality high requirement high efficiency

SPECIFICATION FOR APPROVAL

CUSTOMER :

CLIENT TYPE:

PRODUCTION NO: QSG12864-92-BTDLWH-R

SHIPMENT DATE: 2007-08-09

Customer Checked	
VALIDATED	

	SIGNATURE	DATE
PREPARED		
CHECKED		
APPROVED		

Note: Please fax back after confirmation. Thanks!

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3. GENERAL SPECIFICATIONS :

3-1 SCOPE:

This specification covers the delivery requirements for the liquid crystal display delivered by QUALITY to Customer.

3-2 PRODUCTS:

Liquid Crystal Display Module (LCM)

3-3 MODULE NAME:

QSG12864-92-BTDLWH-R

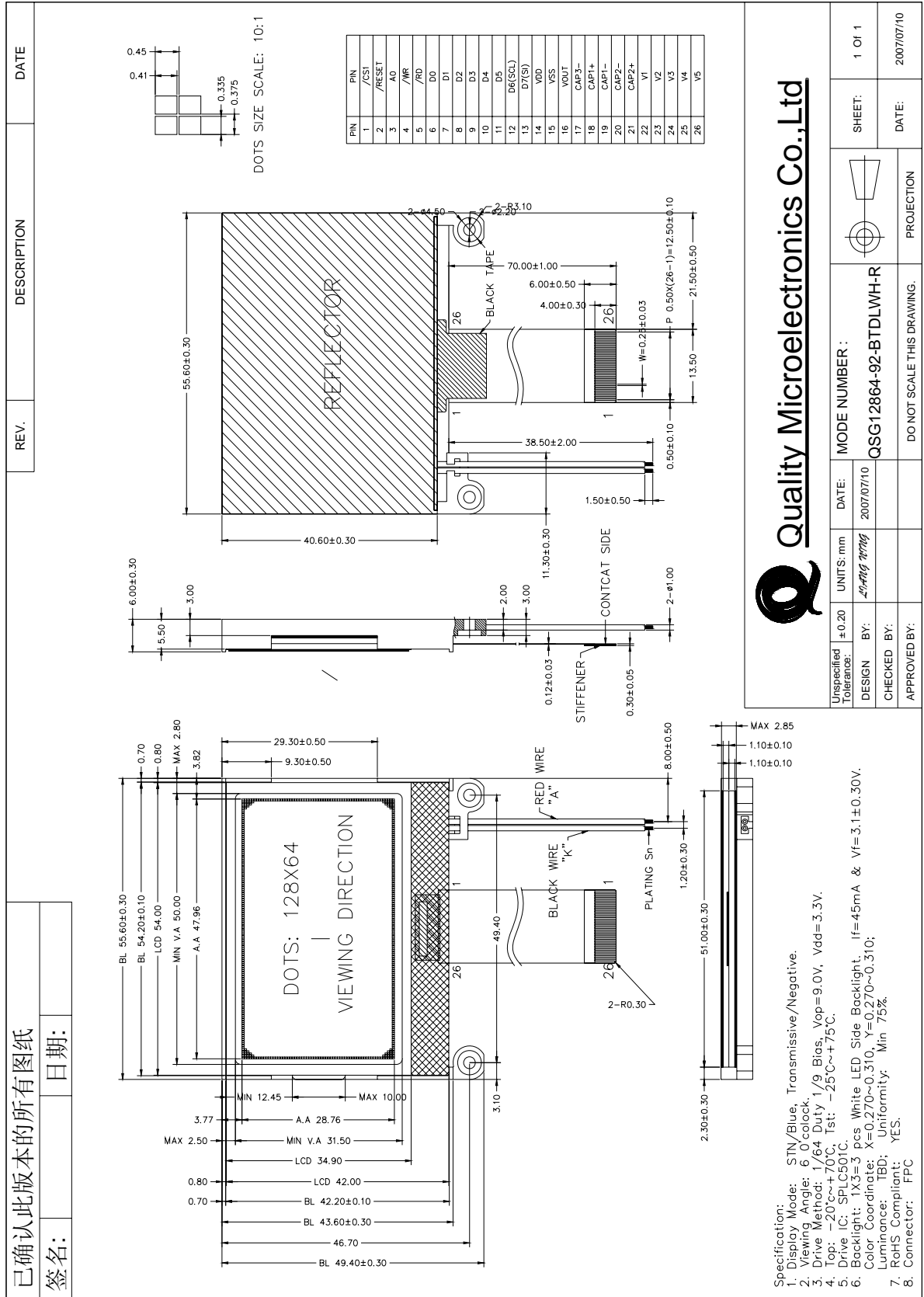
4. FEATURES :

- (1) Display Type: STN(BLUE), 6 O'CLOCK, Transmissive/Negative
- (2) Driving Method: 1/64 DUTY, 1/9 BIAS
- (3) Built-in controller: SPLC501C
- (4) LED Backlight: White, Vf= 3.1V
- (5) VDD=3.3V, VOP=9.0V

5. MACHANICAL SPECIFICATIONS :

ITEM	SPECIFICATIONS	UNIT
MODULE SIZE	55.60(W)x112.20(H)x6.0MAX(D)	mm
VIEWING AREA	50.00 (W) x31.50(H)	mm
ACTIVE AREA	47.96(W) x28.76(H)	mm
DOT SIZE	0.41(W) x 0.335 (H)	mm
DOT PITCH	0.45(W) x 0.375(H)	mm
BACKLIGHT	White	—
ASSY.TYPE	COG	---
WEIGHT	TBD	g

6. OUTLINE DIMENSIONS



7. ABSOLUTE MAXIMUM RATING

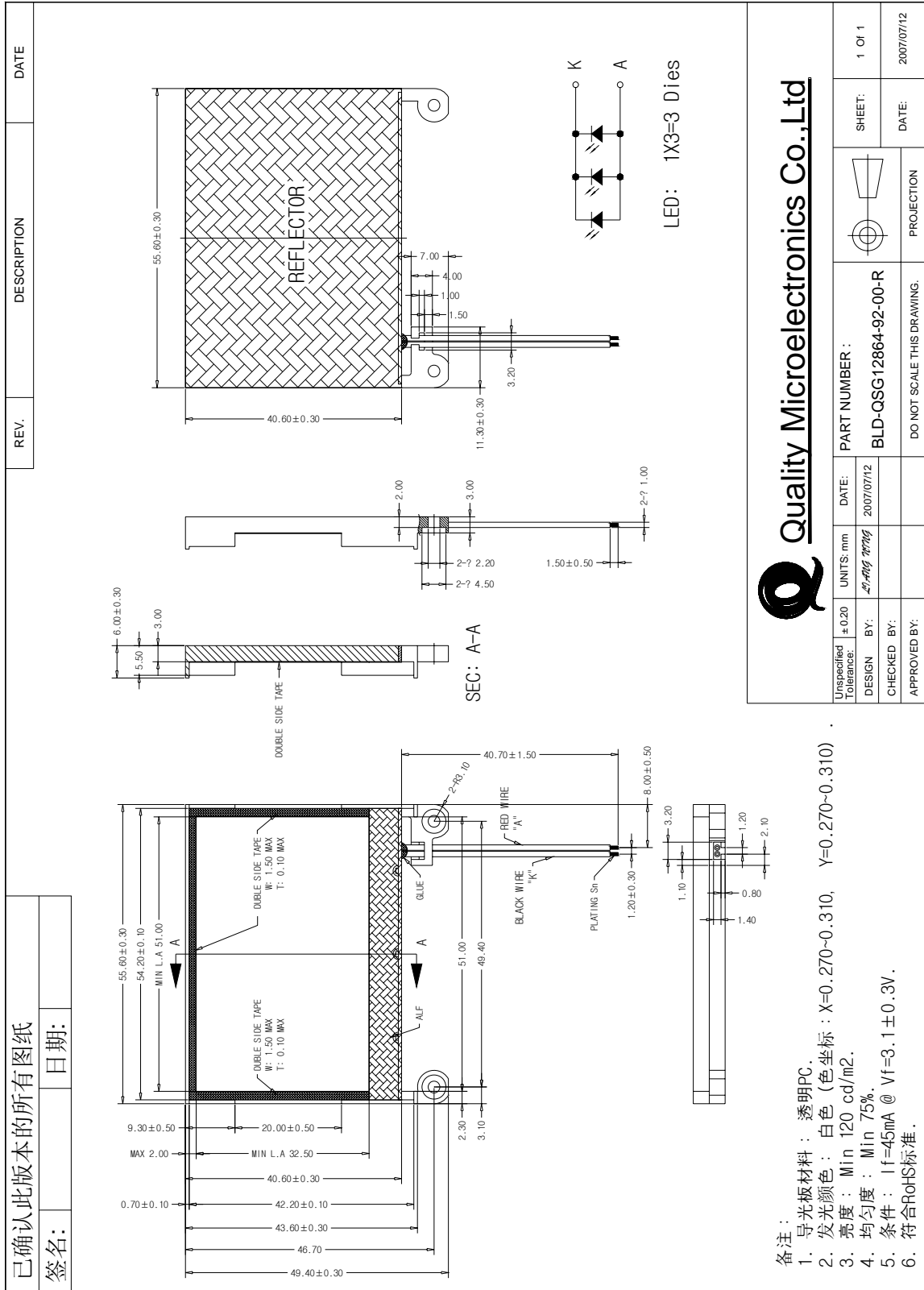
ITEM	SYMBOL	STANDARD VALUE			UNIT
		MIN	TYP	MAX	
DC Supply Voltage	VDD	-0.3	—	7.0	V
	Vout	-12.0	—	0.3	V
	V0	-12.0	—	0.3	V
Input Voltage	VIN	-0.3	—	VDD+0.3	V
Operating temperature	TOPR	-20	—	+70	°C
Storage temperature Bare chip	TSTR	-25	—	+75	°C

8. ELECTRICAL CHARACTERISTICS

DC Characteristics (VSS = 0V, VDD = 3.0V,)

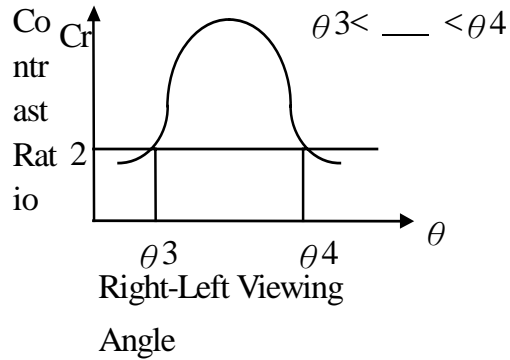
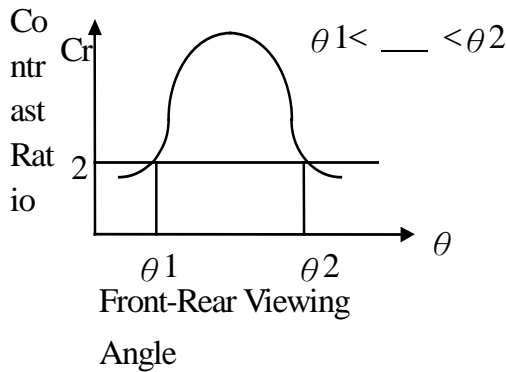
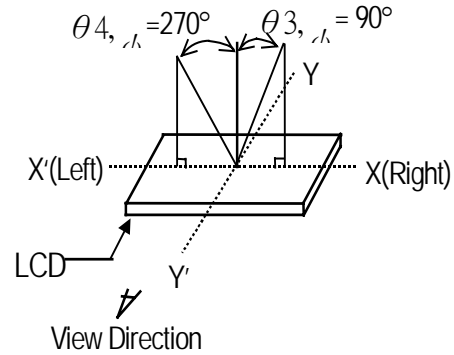
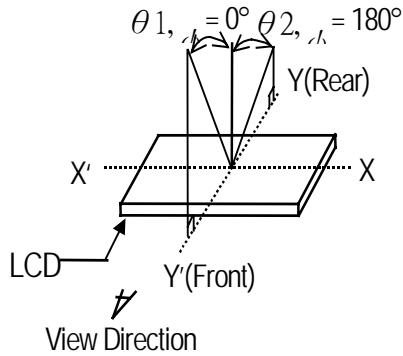
Item	Symbol	Condition	Rating			Units	Applicable PIN
			Min.	Typ.	Max.		
Operating Voltage (1)	Recommended Voltage Possible Operating Voltage	VDD	2.7	-	3.3	V	VDD*1
			2.4	-	5.5	V	VDD*1
Operating Voltage (2)	Recommended Voltage Possible Operating Voltage	VSS2 (Relative to VDD)	-3.3	-	-2.7	V	VSS2
		VSS2 (Relative to VDD)	-6.0	-	-1.8	V	VSS2
Operating Voltage (3)	Possible Operating Voltage	V _S (Relative to VDD)	-12.0	-	-4.5	V	V _S *2
	Possible Operating Voltage	V ₁ , V ₂ (Relative to VDD)	0.4 x V _S	-	VDD	V	V ₁ , V ₂
	Possible Operating Voltage	V ₃ , V ₄ (Relative to VDD)	V _S	-	0.6 x V _S	V	V ₃ , V ₄
High-level Input Voltage	V _{IHC}		0.8 x VDD	-	VDD	V	*3
Low-level Input Voltage	V _{ILC}		VSS	-	0.2 x VDD	V	*3
High-level Input Voltage	V _{OHC}	I _{OH} = -0.5mA	0.8 x VDD	-	VDD	V	*4
Low-level Input Voltage	V _{OLC}	I _{OL} = 0.5mA	VSS	-	0.2 x VDD	V	*4
Input leakage current	I _I	V _{IN} = VDD or VSS	-1.0	-	1.0	μA	*5
Output leakage current	I _{LO}		-3.0	-	3.0	μA	*6
Liquid Crystal Driver ON Resistance	R _{OH}	T _A = 25°C	-	2.0	3.5	KΩ	SEg _n
		(Relative To VDD)	-	3.2	5.4	KΩ	COM _n *7
Static Consumption Current	I _{SS0}		-	0.01	5	μA	VSS, VSS2
Output Leakage Current	I _{SO}	V _S = -12V (Relative to VDD)	-	0.01	15	μA	V _S
Input Terminal Capacitance	C _{IN}	T _A = 25°C; f = 1.0MHz	-	5.0	8.0	pF	
Oscillator Frequency	Internal Oscillator	f _{OSC}	18	22	26	KHz	*8
	External Input	f _{CL}	18	22	26	KHz	CL

9. LED BACKLIGHT



10 .OPTICAL CHARACTERISTICS

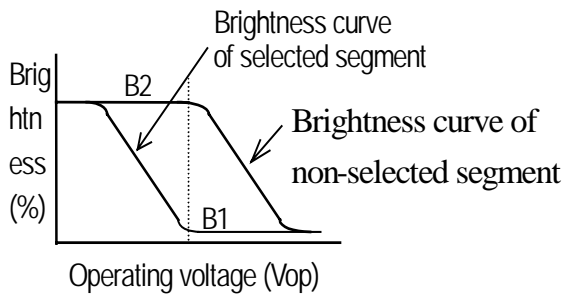
(1) DEFINITION OF VIEWING ANGLE



(2) DEFINITION OF CONTRAST

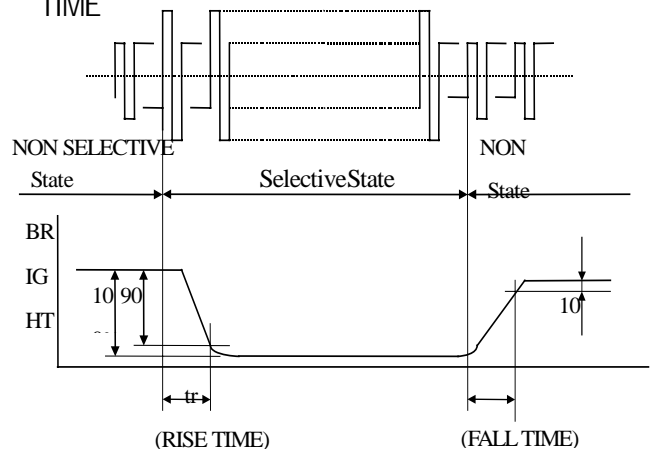
RATIO

$$C.R = \frac{\text{Brightness of nonselected segment (B2)}}{\text{Brightness of selected segment}}$$

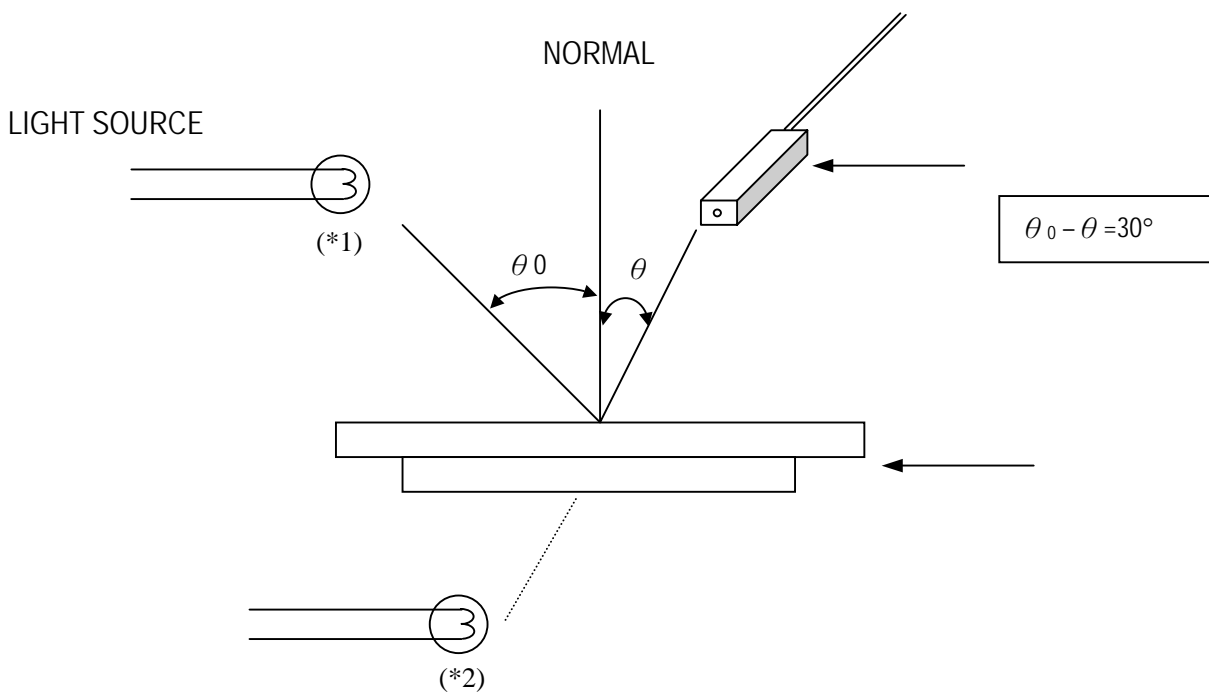


(3) DEFINITION OF RESPONSE

TIME



(3) Measuring Instruments For Electro-optical Characteristics

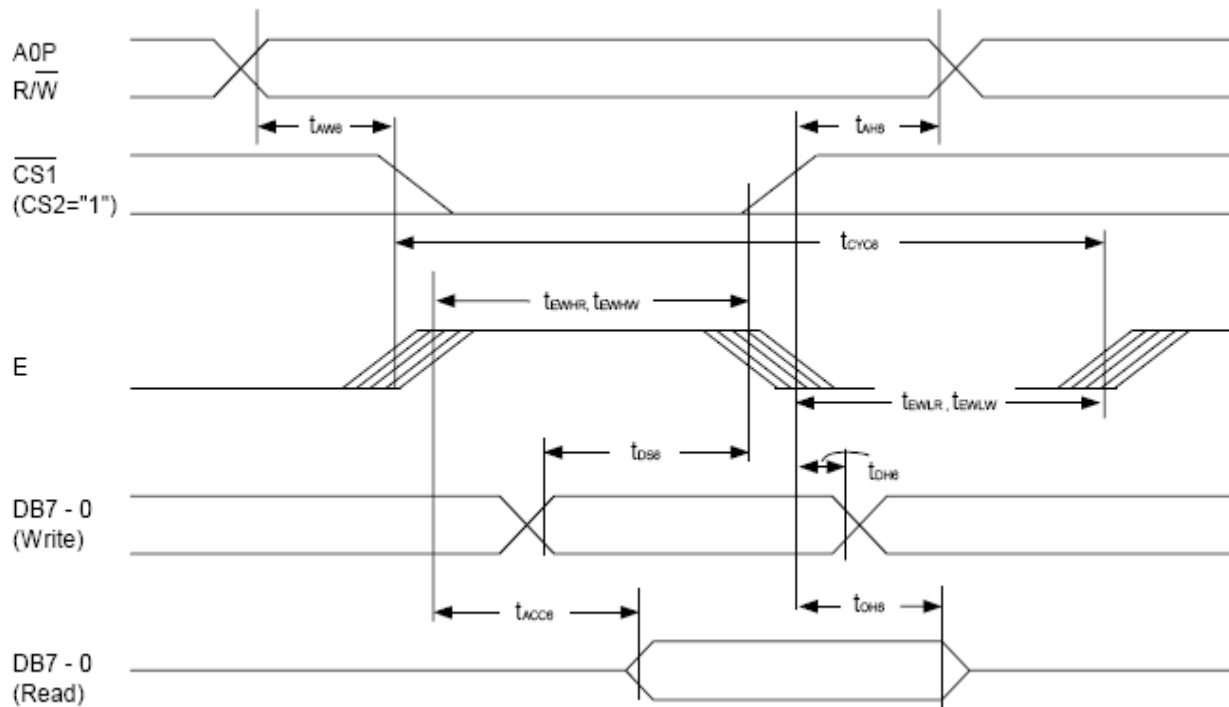


*1.Light source position for measuring the reflective type of LCD panel

*2.Light source position for measuring the transfective / transmissive types of LCD panel

11. TIMING CHARACTERISTICS

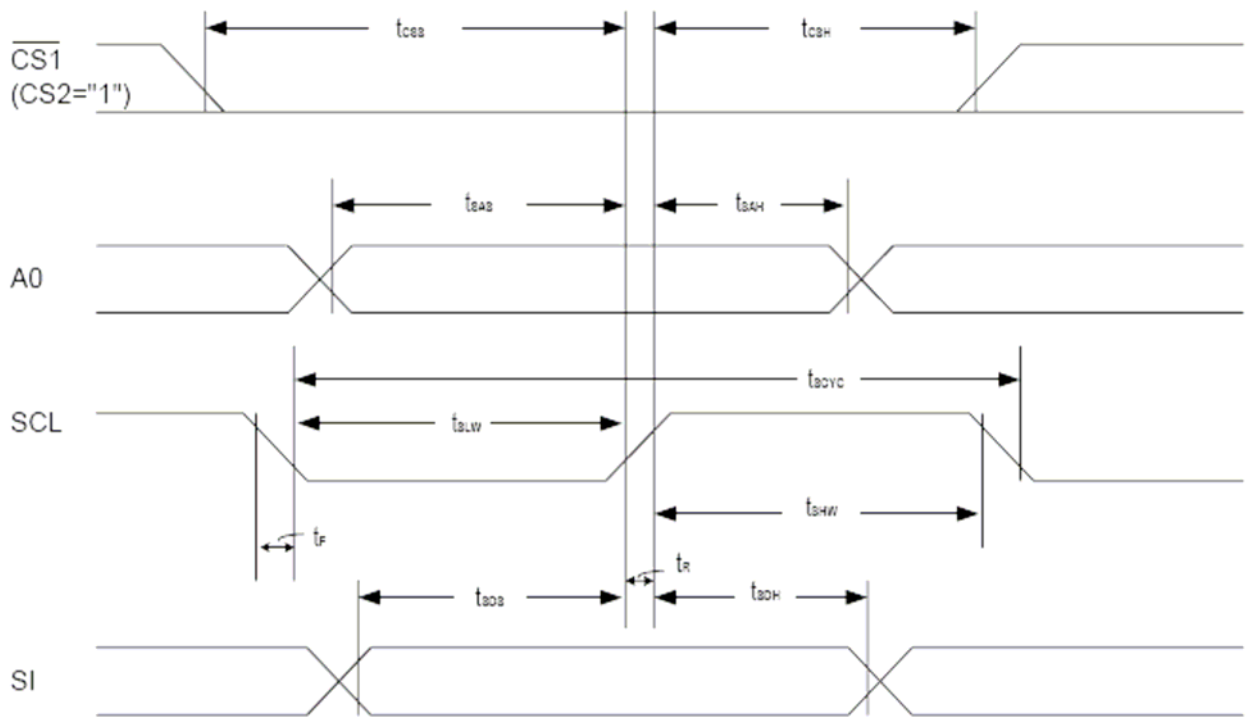
System Buses Read/Write Characteristics (for 8080 Series MPU)



(VDD = 2.7 ~ 4.5V)

Item	Signal	Symbol	Condition	Rating		Units
				Min.	Max.	
Address hold time	A0P	t_{AHS}		0	-	ns
Address setup time	A0P	t_{AHB}		0	-	ns
System cycle time	A0P	t_{CYS}		300	-	ns
Data setup time	DB7 - 0	t_{DSE}	$C_L = 100 \text{ pF}$	40	-	ns
Data hold time		t_{DHE}		15	-	ns
Access time	DB7 - 0	t_{AOCE}		-	140	ns
Output disable time		t_{OHS}		10	100	ns
Enable H pulse time	Read	EP	t_{EWHR}	120	-	ns
	Write	EP	t_{EWHW}	60	-	ns
Enable L pulse time	Read	EP	t_{EWLR}	60	-	ns
	Write	EP	t_{EWLW}	60	-	ns

System Buses Read/Write Characteristics (for 6800 Series MPU)

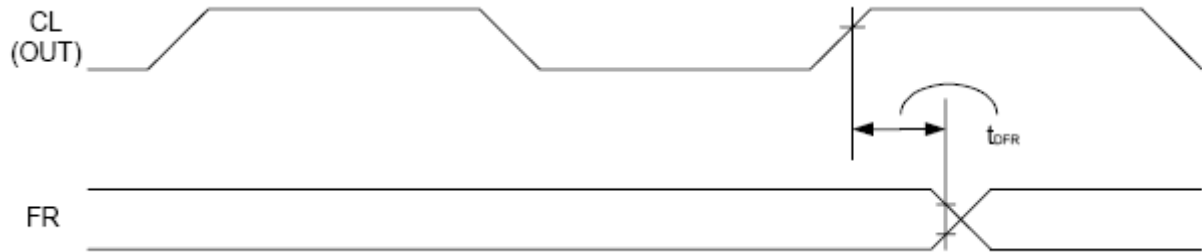


(VDD = 2.7 ~ 4.5V)

Item	Signal	Symbol	Condition	Rating		Units
				Min.	Max.	
Serial Clock Period		t_{SCLCYC}	-	250	-	ns
SCL 'H' pulse width	SCL	t_{SCLH}	-	100	-	ns
SCL 'L' pulse width		t_{SCLW}	-	100	-	ns
Address setup time	A0P	t_{SAS}	-	150	-	ns
Address hold time		t_{SAH}	-	150	-	ns
Data setup time	SI	t_{SDS}	-	100	-	ns
Data hold time		t_{SDH}	-	100	-	ns
CS-SCL time	CS	t_{CSA}	-	150	-	ns
		t_{CSH}	-	150	-	ns

DISPLAY CONTROL OUTPUT TIMING

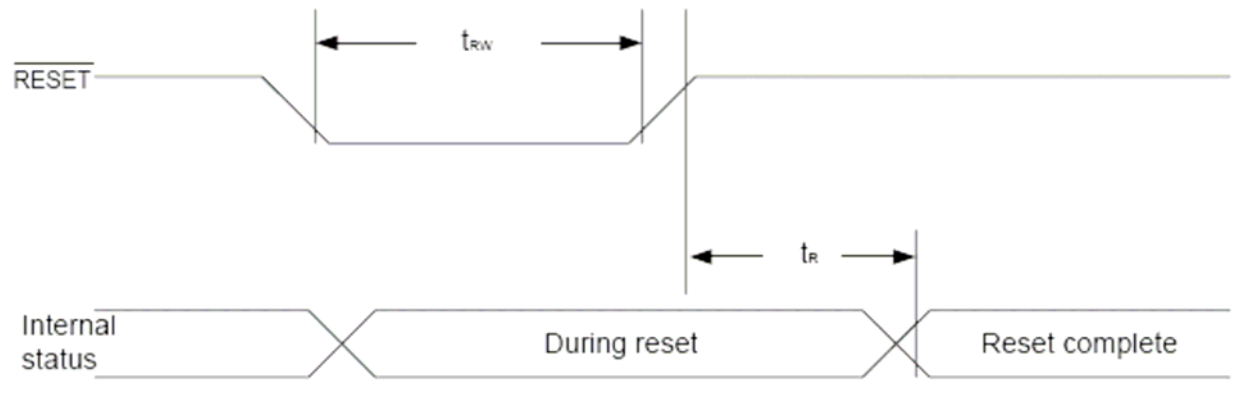
(VDD = 2.7 ~ 4.5V)



(VDD = 2.7 ~ 4.5V)

Item	Signal	Symbol	Condition	Rating			Units
				Min.	Typ.	Max.	
FR delay time	FR	t_{DFR}	$C_L = 50\text{pF}$	-	20	80	ns

RESET TIMING



(VDD = 2.7 ~ 4.5V)

Item	Signal	Symbol	Condition	Rating			Units
				Min.	Typ.	Max.	
Reset time		t_R	-	-	1.0	μs	
Reset 'L' pulse width	RES	t_{RW}	-	1.0	-	-	μs

12. PIN ASSIGNMENT

PIN NO.	FUNCTION DESCRIPTIONS	SYMBOL
1	This is the chip select signal.	/CS
2	When RESET is set to 'L', the settings are initialized. The RESET signal level performs the reset operation.	/RESET
3	This is connected to the least significant bit of the normal MPU address bus, and it determines whether the data bits are data or a command. A0P = 'H': Indicates DB7 - 0 is display data. A0P = 'L': Indicates DB7 - 0 is control data.	A0
4	When connected to an 8080 MPU, this is LOW active. This terminal connects to the 8080 MPU WR signal. The signals on the data bus are latched at the rising edge of the WR signal. When connected to a 6800 Series MPU: This is the read/write control signal input terminal. When RWP = 'H': Read. When RWP = 'L': Write.	/WR
5	When connected to an 8080 MPU, this is LOW active. This pin is connected to the RD signal of the 8080 MPU, and the SPLC501C data bus is in an output status when this signal is 'L'. When connected to a 6800 Series MPU, this is HIGH active. This is the 68000 Series MPU enable clock input terminal.	/RD
6-13	This is an 8-bit bi-directional data bus that connects to an 8-bit or 16-bit standard MPU data bus. When the serial interface is selected (PS = 'L'), DB7 serves as the serial data input terminal (SI) and DB6 serves as the serial clock input terminal (SCL). At the same time, DB5 - 0 are set to high impedance. When the chip select is inactive, DB0 to DB7 are set to high impedance.	D0-D7
14	VDD Shared with MPU power supply terminal VCC	VDD
15	0V terminal connected to the system GND.	VSS
16	DC/DC voltage converter. A capacitor is connected between this terminal and VSS.	VOUT
17	DC/DC voltage converter. A capacitor is connected between this terminal and the CAP1P terminal.	CAP3-
18	DC/DC voltage converter. A capacitor is connected between this terminal and the CAP1N terminal.	CAP1+
19	DC/DC voltage converter. A capacitor is connected between this terminal and the CAP1P terminal.	CAP1-
20	DC/DC voltage converter. A capacitor is connected between this terminal and the CAP2P terminal.	CAP2-
21	DC/DC voltage converter. A capacitor is connected between this terminal and the CAP2N terminal.	CAP2+

22-26

A multi-level power supply for the liquid crystal drive. The voltage applied is determined by the liquid crystal cell, and is changed through the use of a resistive voltage divider or through changing the impedance using an op. amp. Voltage levels are determined based on VDD, and must maintain the relative magnitudes shown below.

$V_{DD} (= V_0) \geq V_1 \geq V_2 \geq V_3 \geq V_4 \geq V_5$

Master operation: When the power supply turns ON, the internal power supply circuits generate the V_1 to V_4 voltages shown below. The voltage settings are selected by the LCD bias command.

SPLC501C		
V_1	$1/9 \cdot V_5$	$1/7 \cdot V_5$
V_2	$2/9 \cdot V_5$	$2/7 \cdot V_5$
V_3	$7/9 \cdot V_5$	$5/7 \cdot V_5$
V_4	$8/9 \cdot V_5$	$6/7 \cdot V_5$

V1-V5

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13. ENVIRONMENTAL ABSOLUTE MAXIMUM RATINGS

ITEM	SYMBOL	CONDITIONS	CRITERION
OPERATING TEMPERATURE	TOPR	-20°C ~ +70°C	NO DEFECT IN DISPLAYING AND OPERATIONAL FUNCTION
STORAGE TEMPERATURE	TSTG	-25°C ~ +75°C	NO DEFECT IN DISPLAYING AND OPERATIONAL FUNCTION

14. RELIABILITY

ITEM	CONDITIONS	CRITERION
OPERATING TEMPERATURE	HIGH TEMPERATURE +70°C 24HRS	NO DEFECT IN DISPLAYING AND OPERATIONAL FUNCTION
	LOW TEMPERATURE -20°C 24HRS	
STORAGE TEMPERATURE	HIGH TEMPERATURE +75°C 240HRS	NO DEFECT IN DISPLAYING AND OPERATIONAL FUNCTION
	LOW TEMPERATURE -25°C 240HRS	
HUMIDITY	40°C 90%RH 240HRS	NO DEFECT IN DISPLAYING AND OPERATIONAL FUNCTION
VIBRATION	<ul style="list-style-type: none"> • Operating Time: thirty minutes exposure for each direction (X,Y,Z) • Sweep Frequency: 10~55Hz (1 min) • Amplitude: 1.5mm 	NO DEFECT IN DISPLAYING AND OPERATIONAL FUNCTION
THERMAL SHOCK	-20°C (30mins) ←→ +65°C (30mins) 10 cycles	NO DEFECT IN DISPLAYING AND OPERATIONAL FUNCTION

*NOTE: TEST CONDITION

(1) TEMPERATURE AND HUMIDITY: IF NO SPECIFICATION, TEMP. SET AT 25±2°C, HUMIDITY SET AT 60±5%RH

(2) OPERATING STATE: SAMPLES SUBJECT TO THE TESTS SHALL BE IN "OPERATING" CONDITION

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15. Precaution for Use

The following precautions should be followed, since this module contains precise parts.

- (1) Do not store module for an extended periods of time under the conditions of high temperature and high humidity.
- (2) Avoid using or storing the module in areas that expose it to direct sunlight or ultraviolet rays.
- (3) Use protective finger covers when handling the module to avoid scratching or staining the module.
- (4) Care should be taken not to expose the module to static electricity, because the module contains C-MOS LSI's.
- (5) The LSI is sensitive to light.

The user's product should be designed so that LSI is not exposed to any light during operation.

- (6) During installation, cover the display area with acrylic protection plates to protect the polarizer plate and LCD cells.
- (7) Do not apply any excessive shocks to the module because the module contains sensitive LCD cells.
Do not use a module, which has experienced strong mechanical shock.
- (8) Care should be taken when the power supply turns on as following.
 - (a) Do not apply any input signals before the supplying voltage is applied.
 - (b) Do not turn off the power supply while any input signals are applied.

Caution

- (1) Dangerous. Do not shock glass because glass can break.
- (2) If module breaks, do not touch it directly.
(Glass could stick or cut skin.)
- (3) Do not swallow Liquid Crystal.
(In case of broken LCD panel, do not swallow liquid crystal even if there is no proof that liquid crystal is poisonous.)
- (4) If liquid crystal is exposed to skin, wash the area thoroughly with alcohol or soap.
- (5) When disposing of the product, please observe industrial waste disposal laws in each country and district.
- (6) In case of injury, give immediate treatment and consult with a doctor.
- (7) This product is constructed precisely. Don't disassemble or modify.

※ Neglecting this mark can cause injury to humans and damage to materials